JRM:lmp 11/20/07 P0889D PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Art Unit: 1711

Brian Labrec Confirmation No.: 4087

Application No.: 10/677,092 Filed: September 30, 2003

For: INCREASING THERMAL

CONDUCTIVITY OF HOST POLYMER USED WITH LASER ENGRAVING METHODS AND COMPOSITIONS

METHODS AND COMPOSITIONS

VIA ELECTRONIC FILING

Examiner: S. McClendon Date: November 20, 2007

AMENDMENT

COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Responsive to the Office Action mailed June 20, 2007, please amend the subject application as follows: